TEL:+86-0755-27876201 http://www.kangbidz.com

# 深圳康比电子有限公司

声表面谐振器: %% F' % A



KANGBI TECHNOLOGY INDUSTRY CO.,LTD.

# 产品规格书

# SAMPLE APPROVAL SHEET

CUSTOMER客户:	
SIZE UP规格:	HB3 -DIP
MODEL型号:	R537M
NUMBER数量:	
DATE日期:	

Customer's Approval Certificate Please return this copy as a certification of Y our approval

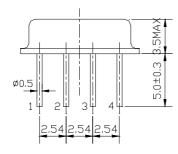
Checked & Approval by:

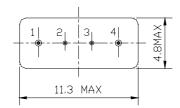
Date:

# 1. Package Dimension

(F-11)







Unit: mm

Pin No. Function

- 1. Input
- 2. Ground
- 3. Ground
- 4. Output

# 2. Marking

KON 315.00

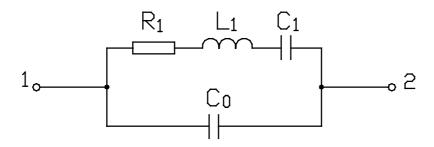
1. Color: Black or Blue

2. DR: Manufacture's logo

3. 1: One-port SAW Resonator

4. 315.00: Center Frequency (MHz)

# 3. Equivalent LC Model



# 4. Performance

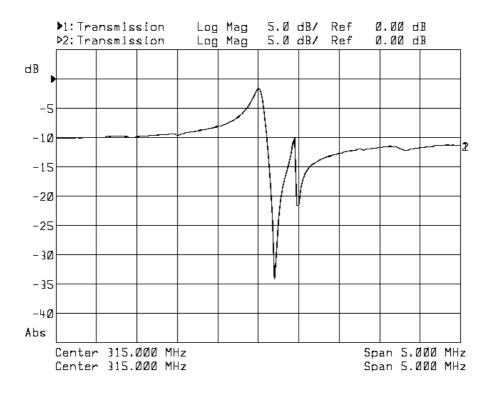
# 4.1 Maximum Rating

DC Voltage V <sub>DC</sub>	10V		
AC Voltage V <sub>PP</sub>	10V (50Hz/60Hz)		
Operation Temperature	-40 to +85		
Storage Temperature	-45 to +85		
RF Power Dissipation	0dBm		

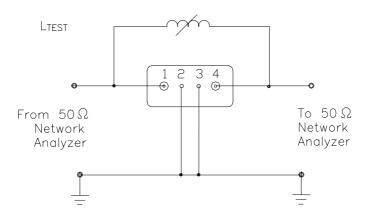
#### 4.2 Electronic Characteristics

Item		Units	Minimum	Typical	Maximum
Center Frequency fo		MHz	314.925	315	315.075
Insertion Loss		dB	_	1.3	2.5
Quality Factor	Unloaded Q	_	_	12,000	_
	50 Loaded Q	_	_	1,900	_
Temperature	Turnover Temperature		10	25	40
Stability	Turnover Frequency	KHz	_	fo	_
	Freq.Temp.Coefficient	ppm/ <sup>2</sup>	_	0.037	_
Frequency Aging		ppm/yr	_	<±10	_
DC Insulation Resistance		M	1.0	_	_
	Motional Resistance R <sub>1</sub>		_	23	29
RF Equivalent RLC Model	Motional Inductance L <sub>1</sub>	μН	_	115.2	_
	Motional Capacitance C <sub>1</sub>	fF	_	2.2	_
	Shunt Static Capacitance Co	pF	2.1	2.4	2.7

#### 4.3 Frequency Characteristics



#### 4.4 Test Circuit



Note: Reference temperature shall be  $25 \pm 2$  . However, the measurement may be carried out at 5 to 35 unless there is a dispute.

#### 5. Reliability

- 5.1 Mechanical Shock: The components shall remain within the electrical specifications after 1000 shocks, acceleration 392 m/s<sup>2</sup>, duration 6 milliseconds.
- 5.2 Vibration Fatigue: The components shall remain within the electrical specifications after loaded vibration at 20 Hz, amplitude 1.5 mm, for 2 hours.
- 5.3 Terminal Strength: The components shall remain within the electrical specifications after pulled 2 kgs weight for 10 seconds towards an axis of each terminal.
- 5.4 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the  $85 \pm 2$  for 48 hours, then kept at room temperature for 2 hours.
- 5.5 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the -25  $\pm 2$  for 48 hours, then kept at room temperature for 2 hours.
- 5.6 Temperature Cycle: The components shall remain within the electrical specifications after 5 cycles of high and low temperature testing (one cycle: 80 for 30 minutes

  25 for 5 minutes -25 for 30 minutes )than kept at room temperature for 2 hours.
- 5.7 Solder-heat Resistance: The components shall remain within the electrical specifications after dipped in the solder at 260 for  $10 \pm 1$  seconds, then kept at room temperature for 2 hours. (Terminal must be dipped leaving 1.5 mm from the case).
- 5.8 Solderability: Solderability of terminal shall be kept at more than 80% after dipped in the solder flux at 230  $\pm 5$  for  $5 \pm 1$  seconds.

#### 6. Remarks

#### 6.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

#### 6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning.

#### 6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.